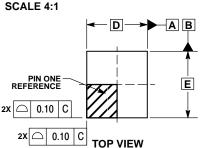
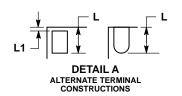
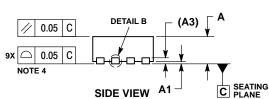


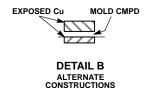


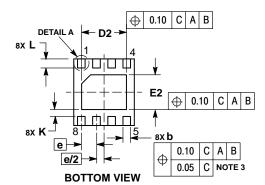
DATE 13 JAN 2010











- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND
- 0.30 mm FROM TERMINAL.

 COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	TYP	MAX
Α	0.80		1.00
A1	0.00		0.05
A3	0.20 REF		
b	0.20		0.30
D	2.00 BSC		
D2	1.43		1.53
E	2.20 BSC		
E2	1.05		1.25
е	0.50 BSC		
K	0.20	0.22	0.30
L	0.25		0.35
L1			0.15

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

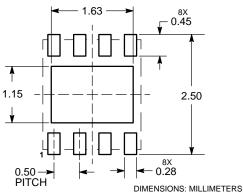
= Date Code

= Pb-Free Device

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	DFN8, 2.0X2.2, 0.5P		PAGE 1 OF 1	

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